INTEGRATED CIRCUITS

DATA SHEET

74F283

4-bit binary full adder with fast carry

Product specification

1989 Mar 03

IC15 Data Handbook





74F283

FEATURES

- High speed 4-bit addition
- Cascadable in 4-bit increments
- Fast Internal carry look-ahead

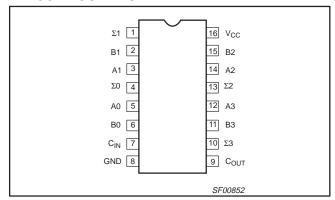
DESCRIPTION

The 74F283 adds two 4-bit binary words (An plus Bn) plus the incoming carry. The binary sum appears on the sum outputs $(\Sigma 0-\Sigma 3)$ and the outgoing carry (C_{OUT}) according to the equation: $C_{IN}+2^0(A0+B0)+2^1(A1+B1)+2^2(A2+B2)+2^3(A3+B3)\\ =\Sigma 0+2\Sigma 1+4\Sigma 2+8\Sigma 3+16C_{OUT}$ where (+)=plus

Due to the symmetry of the binary add function, the 74F283 can be used with either all active-High operands (positive logic) or with all active-Low operands (negative logic). See Function Table. In case of all active-Low operands (negative logic) the results $\Sigma 1-\Sigma 4$ and C_{OUT} should be interpreted also as active-Low. With active-High inputs, C_{IN} cannot be left open; it must be held Low when no "carry in" is intended. Interchanging inputs of equal weight does not affect the operation, thus A0, B0, C_{IN} can arbitrarily be assigned to pins 5, 6, 7, etc.

Due to pin limitations, the intermediate carries of the 74F283 are not brought out for use as inputs or outputs. However, other means can be used to effectively insert a carry into, or bring a carry out from, an intermediate stage.

PIN CONFIGURATION



TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F283	6.5ns	40mA

ORDERING INFORMATION

DESCRIPTION	COMMERCIAL RANGE V_{CC} = 5V $\pm 10\%$, T_{amb} = 0°C to +70°C	PKG DWG #
16-pin plastic DIP	N74F283N	SOT38-4
16-pin plastic SO	N74F283D	SOT109-1

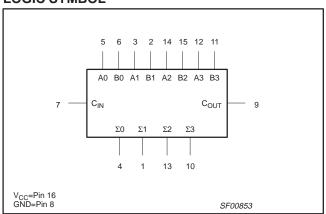
INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F(U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
A0 - A3	A operand inputs	1.0/2.0	20μA/1.2mA
B0 - B3	B operand inputs	1.0/2.0	20μA/1.2mA
C _{IN}	Carry input	1.0/1.0	20μA/0.6mA
C _{OUT}	Carry output	50/33	1.0mA/20mA
Σ0–Σ3	Sum outputs	50/33	1.0mA/20mA

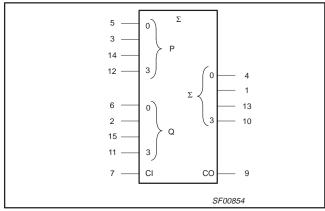
NOTE:

One (1.0) FAST Unit Load is defined as: $20\mu A$ in the High state and 0.6mA in the Low state.

LOGIC SYMBOL



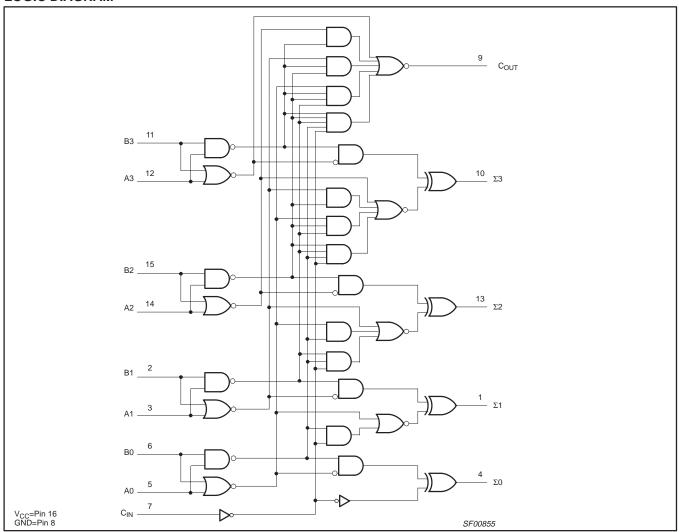
LOGIC SYMBOL (IEEE/IEC)



4-bit binary full adder with fast carry

74F283

LOGIC DIAGRAM



FUNCTION TABLE

PINS	C _{IN}	Α0	A1	A2	А3	В0	B1	B2	В3	Σ0	Σ1	Σ2	Σ3	C _{OUT}	Example: 1001
Logic levels	L	L	Н	L	Н	Н	L	L	Н	Н	Н	L	L	Н	1010
Active High	0	0	1	0	1	1	0	0	1	1	1	0	0	1	10011 (10+9=19)
Active Low	1	1	0	1	0	0	1	1	0	0	0	1	1	0	(carry+5+6=12)

H = High voltage level
L = Low voltage level

1989 Mar 03

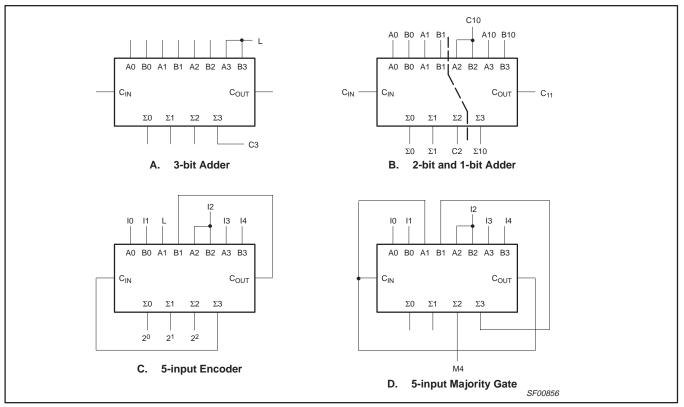
4-bit binary full adder with fast carry

74F283

Figure A shows how to make a 3-bit adder. Tying the operand inputs of the fourth adder (A3, B3) Low makes $\Sigma 3$ dependent only on, and equal to, the carry from the third adder. Using somewhat the same principle, Figure B shows a way of dividing the 74F283 into a 2-bit and a 1-bit adder. The third stage adder (A2, B2, $\Sigma 2$) is used as means of getting a carry (C10) signal into the fourth stage adder (via A2 and B2) and bringing out the carry from the second stage on $\Sigma 2$. Note that as long as A2 and B2 are the same, whether High or Low,

they do not influence $\Sigma 2$. Similarly, when A2 and B2 are the same, the carry into the third stage does not influence the carry out of the third stage. Figure C shows a method of implementing a 5-input encoder where the inputs are equally weighted. The outputs $\Sigma 0$, $\Sigma 1$ and $\Sigma 2$ present a binary number of inputs 10-14 that are true. Figure D shows one method of implementing a 5-input majority gate. When three or more of the inputs 10-14 are true, the output M4 is true.

APPLICATIONS



74F283

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V _{CC}	Supply voltage	-0.5 to +7.0	V
V _{IN}	Input voltage	-0.5 to +7.0	V
I _{IN}	Input current	−30 to +5	mA
V _{OUT}	Voltage applied to output in High output state	–0.5 to V _{CC}	V
l _{OUT}	Current applied to output in Low output state	40	mA
T _{amb}	Operating free-air temperature range	0 to +70	°C
T _{stg}	Storage temperature	-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		UNIT		
STWBOL	PARAMETER	Min	Nom	Max	UNII
V _{CC}	Supply voltage	4.5	5.0	5.5	V
V_{IH}	High-level input voltage	2.0			V
V_{IL}	Low-level input voltage			0.8	V
I _{IK}	Input clamp current			-18	mA
Іон	High-level output current			-1	mA
l _{OL}	Low-level output current			20	mA
T _{amb}	Operating free-air temperature range	0		70	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

						LIMITS				
SYMBOL	PARAME	TER	TEST CONDITIONS	S ^{NO TAG}	MIN	TYP NO TAG	MAX	UNIT		
V	High level output voltage		$V_{CC} = MIN, V_{IL} = MAX$	$V_{CC} = MIN, V_{IL} = MAX$ $\pm 10\% V_{CC}$				V		
V _{OH}	High-level output voltage		$V_{IH} = MIN, I_{OH} = MAX$	±5%V _{CC}	2.7	3.4		V		
V	Low lovel output voltage		$V_{CC} = MIN, V_{IL} = MAX$	±10%V _{CC}		0.30	0.50	V		
V _{OL}	Low-level output voltage		$V_{IH} = MIN, I_{OL} = MAX$	±5%V _{CC}		0.30	0.50	V		
V _{IK}	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$			-0.73	-1.2	V		
I _I	Input current at maximun	n input voltage	$V_{CC} = MAX, V_I = 7.0V$			100	μΑ			
I _{IH}	High-level input current		$V_{CC} = MAX, V_I = 2.7V$				20	μΑ		
1	Low lovel input ourrent	C _{IN} only	\\ MAY \\ 0.5\\				-0.6	mA		
¹ _	Low-level input current An, Bn		$V_{CC} = MAX, V_I = 0.5V$				-1.2	mA		
I _{OS}	Short-circuit output current ^{NO TAG}		V _{CC} = MAX	-60		-150	mA			
I _{CC}	Supply current (total) ⁴		V _{CC} = MAX		40	55	mA			

NOTES:

- 1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- 2. All typical values are at V_{CC} = 5V, T_{amb} = 25°C.
- 3. Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

4. I_{CC} should be measured with all outputs open and the following conditions:

Condition1: all inputs grounded

Condition 2: all B inputs Low, other inputs at 4.5V

Condition 3: all inputs at 4.5V

4-bit binary full adder with fast carry

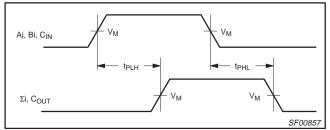
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AC ELECTRICAL CHARACTERISTICS

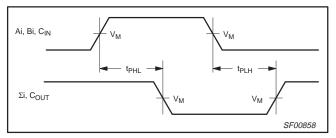
			LIMITS									
SYMBOL	PARAMETER	TEST CONDITIONS	٦	F_{amb} = +25°C V_{CC} = +5.V C_L = 50pF, R_L = 500 Ω	;	T _{amb} = 0°C V _{CC} = +5 C _L = = R _L =	UNIT					
			MIN	TYP	MAX	MIN	MAX					
t _{PLH} t _{PHL}	Propagation delay C_{IN} to Σ i	Waveform 1, 2	3.5 4.0	7.0 7.0	9.5 9.5	3.0 3.5	10.5 10.5	ns ns				
t _{PLH} t _{PHL}	Propagation delay Ai or Bi to Σi	Waveform 1, 2	3.5 3.5	7.0 7.0	9.5 9.5	2.5 3.5	10.5 10.5	ns ns				
t _{PLH} t _{PHL}	Propagation delay C _{IN} to C _{OUT}	Waveform 2	3.5 3.0	5.7 5.4	7.5 7.0	3.5 2.5	8.5 8.0	ns ns				
t _{PLH} t _{PHL}	Propagation delay Ai or Bi to C _{OUT}	Waveform 1, 2	3.5 2.5	5.7 5.3	7.5 7.0	3.0 2.5	8.5 8.0	ns ns				

AC WAVEFORMS

For all waveforms, V_M=1.5V.

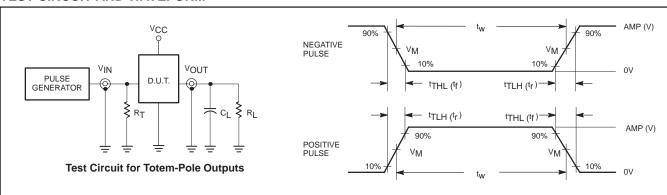


Waveform 1. Propagation Delay Operands and Carry Inputs to Outputs



Waveform 2. Propagation Delay Operands and Carry Inputs to Outputs

TEST CIRCUIT AND WAVEFORM



DEFINITIONS:

R_L = Load resistor;

see AC ELECTRICAL CHARACTERISTICS for value. $C_L = \text{Load capacitance includes jig and probe capacitance;}$

C_L = Load capacitance includes jig and probe capacitance; see AC ELECTRICAL CHARACTERISTICS for value.

R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.

Input Pulse Definition

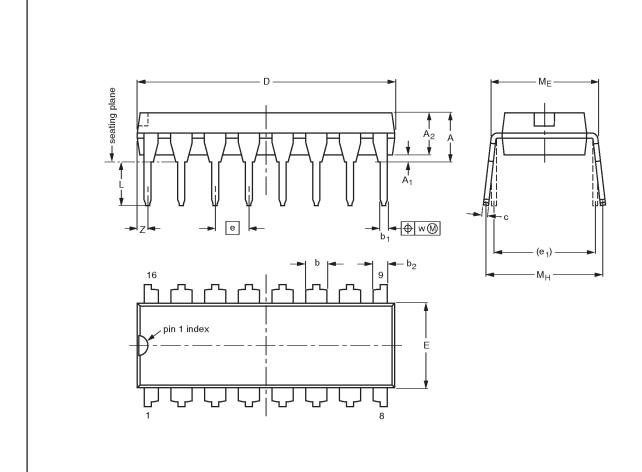
family 74F	INP	UT PU	LSE REQU	REMEN	TS		
lallilly	amplitude 3.0V	V _M	rep. rate	t _w	t _{TLH}	t _{THL}	
74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns	

SF00006

74F283

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

scale

10 mm

Note

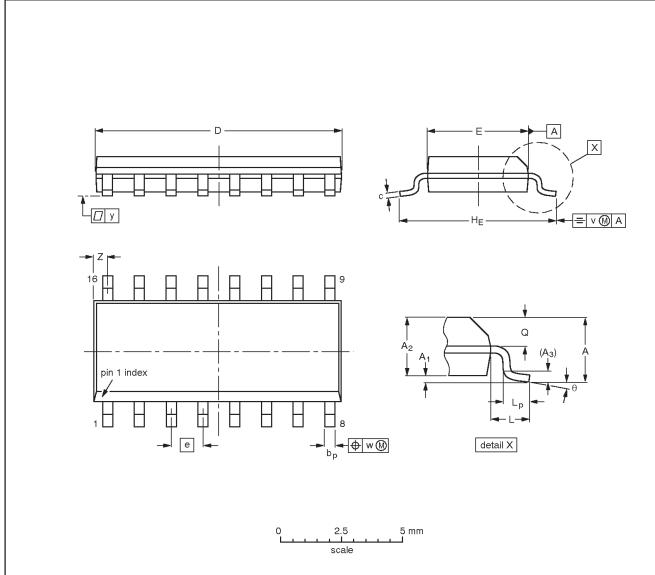
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT38-4					□ •	92-11-17 95-01-14	

74F283

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	c	D ⁽¹⁾	E ⁽¹⁾	e	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT109-1	076E07S	MS-012AC				95-01-23 97-05-22

1989 Mar 03

4-bit binary full adder with fast carry

74F283

NOTES

1989 Mar 03

4-bit binary full adder with fast carry

74F283

Data sheet status

Data sheet status	Product status	Definition [1]	
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.	
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.	
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^[1] Please consult the most recently issued datasheet before initiating or completing a design.

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